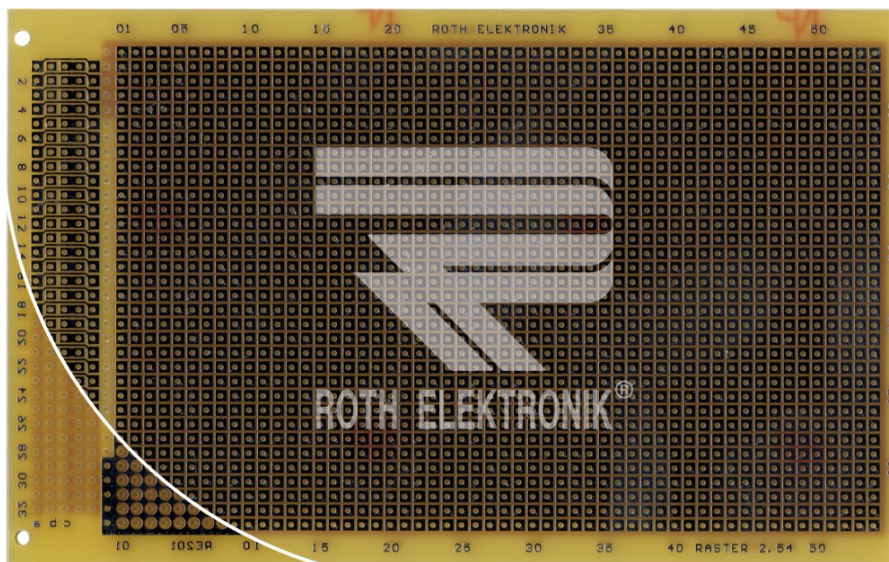


HF-board



RE201-LFDS

- EPOXY fibre-glass FR4 1.5 mm double-sided 35 µm CU (npth)
- hot air leveling (HAL-leadfree)
- 34 x 54 single-hole conductor 2.0 mm²
- hole spacing 2.54 x 2.54 mm
- hole dia 1,0 mm
- connector 32/ 64/ 96-channel
- DIN 41612 type C
- the component side is totally laminated by copper
- only the through-holes are etched free so that a conducting connection to the component side is impossible
- if the copper coating is connected to ground the electrical components are optimally shielded against the solder side
- by this HF, digital and analog circuits can be built up with high reliability
- size 100 x 160 mm